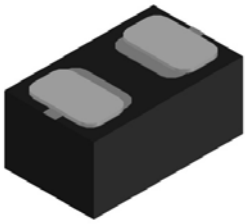
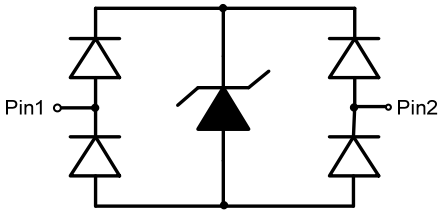
ESD5311X

1-Line, Bi-directional, Ultra-low Capacitance Transient Voltage Suppressors

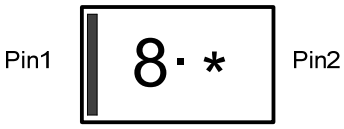
http//:www.willsemi.com



WBFBP-02C-C (Bottom View)



Pin configuration



8 = Device code
* = Month code (A~Z)

Marking (Top View)

Descriptions

The ESD5311X is an ultra-low capacitance TVS (Transient Voltage Suppressor) designed to protect high speed data interfaces. It has been specifically designed to protect sensitive electronic components which are connected to data and transmission lines from over-stress caused by ESD (Electrostatic Discharge).

The ESD5311X incorporates one pair of ultra-low capacitance steering diodes plus a TVS diode.

The ESD5311X may be used to provide ESD protection up to ±20kV (contact discharge) according to IEC61000-4-2, and withstand peak pulse current up to 4A (8/20μs) according to IEC61000-4-5.

The ESD5311X is available in WBFBP-02C-C package. Standard products are Pb-free and Halogen-free.

Features

- Stand-off voltage: 5V Max
- Transient protection for each line according to
  IEC61000-4-2 (ESD): ±20kV (contact discharge)
  IEC61000-4-5 (surge): 4 A (8/20μs)
- Ultra-low capacitance: C_J = 0.25pF typ.
- Ultra-low leakage current: I_R < 1nA typ.
- Low clamping voltage: V_{CL} = 22V typ. @ I_{PP} = 16A (TLP)
- Solid-state silicon technology

Applications

- USB 2.0 and USB 3.0
- HDMI 1.3 and HDMI 1.4
- SATA and eSATA
- DVI
- IEEE 1394
- PCI Express
- Portable Electronics
- Notebooks

Order information

Device	Package	Shipping
ESD5311X-2/TR	WBFBP-02C-C	10000/Tape&Reel

Absolute maximum ratings

Parameter	Symbol	Rating	Unit
Peak pulse power (t_p = 8/20μs)	P_{pk}	72	W
Peak pulse current (t_p = 8/20μs)	I_{PP}	4	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	±20	kV
ESD according to IEC61000-4-2 contact discharge		±20	
Junction temperature	T_J	125	°C
Operating temperature	T_{OP}	-40~85	°C
Lead temperature	T_L	260	°C
Storage temperature	T_{STG}	-55~150	°C

Electrical characteristics (T_A=25°C, unless otherwise noted)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse maximum working voltage	V_{RWM}				5.0	V
Reverse leakage current	I_R	V_{RWM} = 5V		<1	100	nA
Reverse breakdown voltage	V_{BR}	I_T = 1mA	7.5	9.0	10.0	V
Clamping voltage *1)*	V_{CL}	I_{PP} = 16A, t_p = 100ns		22		V
Dynamic resistance *1)*	R_{DYN}			0.7		Ω
Clamping voltage *2)*	V_{CL}	V_{ESD} = 8kV		22		V
Clamping voltage *3)*	V_{CL}	I_{PP} = 1A, t_p = 8/20μs			13	V
		I_{PP} = 4A, t_p = 8/20μs			18	V
Junction capacitance	C_J	V_R = 0V, f = 1MHz		0.25	0.4	pF

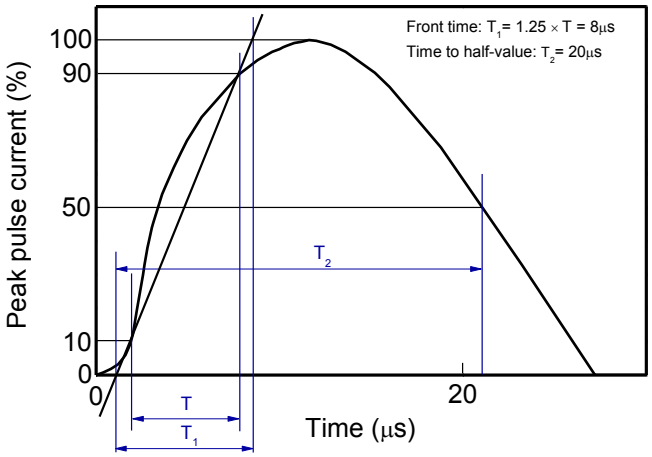
Notes:

1) TLP parameter: Z_0 = 50Ω, t_p = 100ns, t_r = 2ns, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.

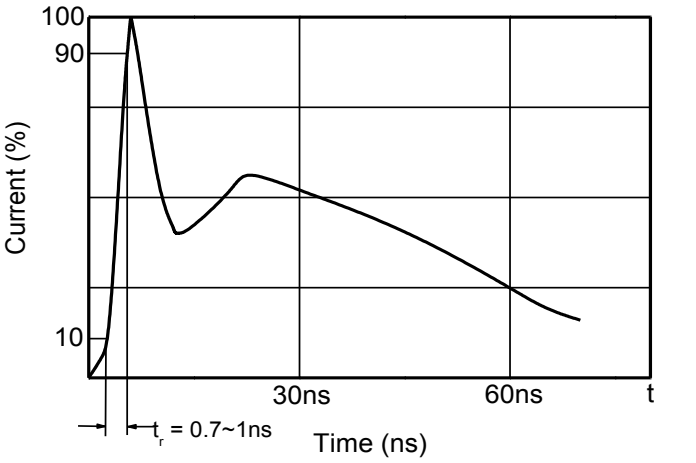
2) Contact discharge mode, according to IEC61000-4-2.

3) Non-repetitive current pulse, according to IEC61000-4-5.

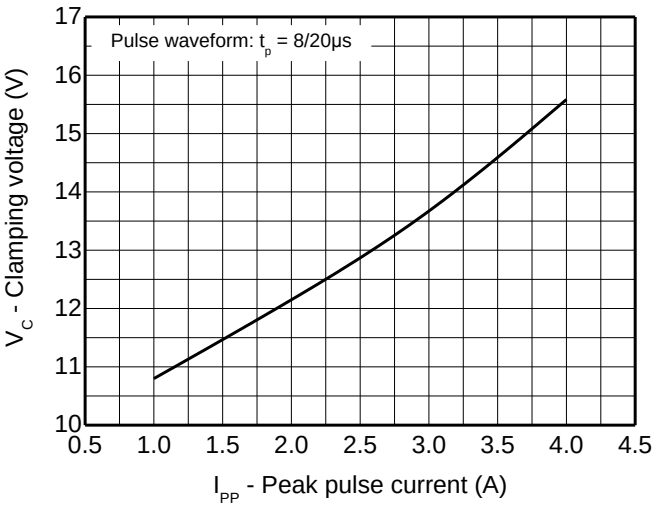
Typical characteristics (T_A=25°C, unless otherwise noted)



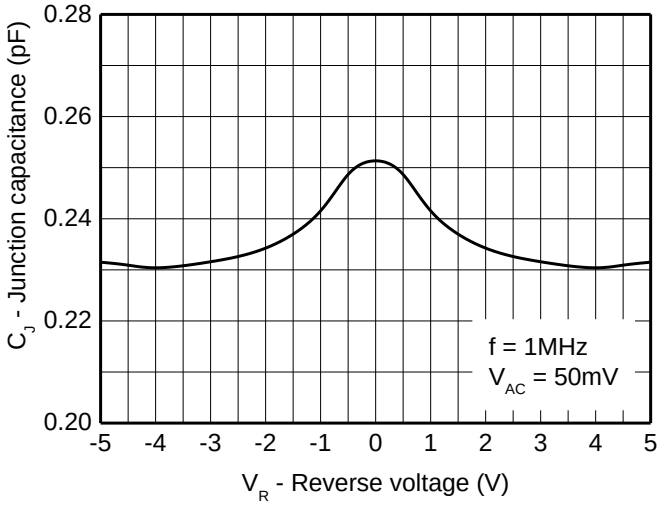
8/20μs waveform per IEC61000-4-5



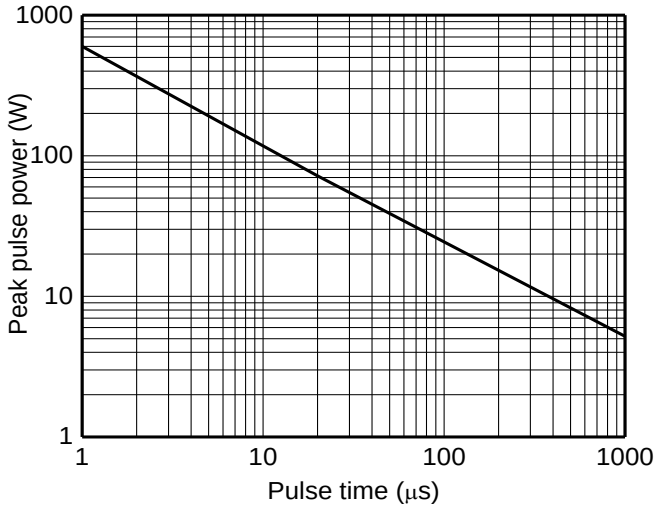
Contact discharge current waveform per IEC61000-4-2



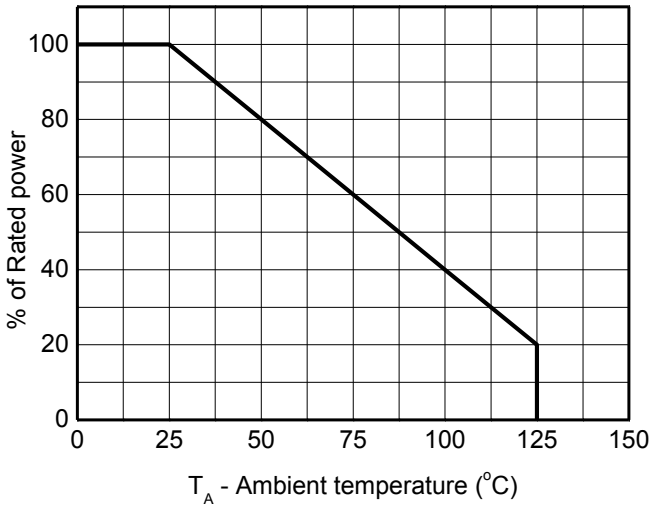
Clamping voltage vs. Peak pulse current



Capacitance vs. Reverse voltage

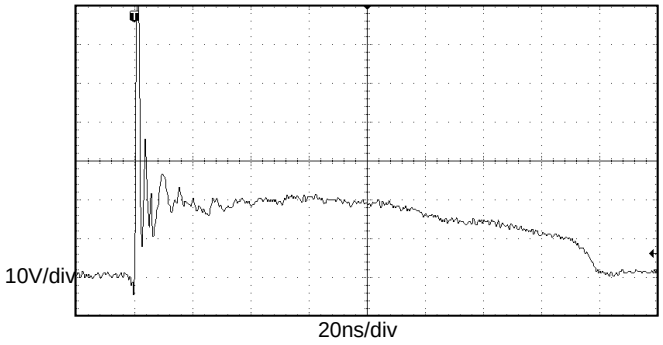


Non-repetitive peak pulse power vs. Pulse time

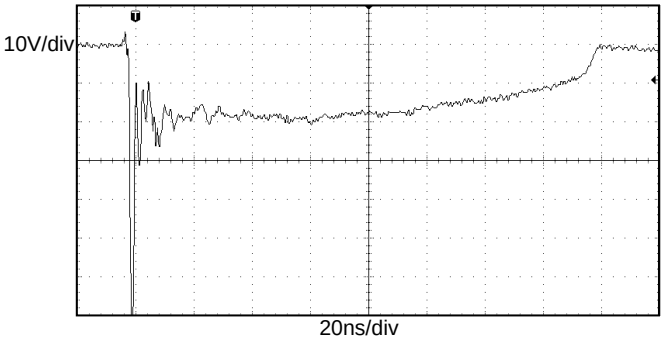


Power derating vs. Ambient temperature

Typical characteristics (T_A = 25°C, unless otherwise noted)



ESD clamping
(+8kV contact discharge per IEC61000-4-2)



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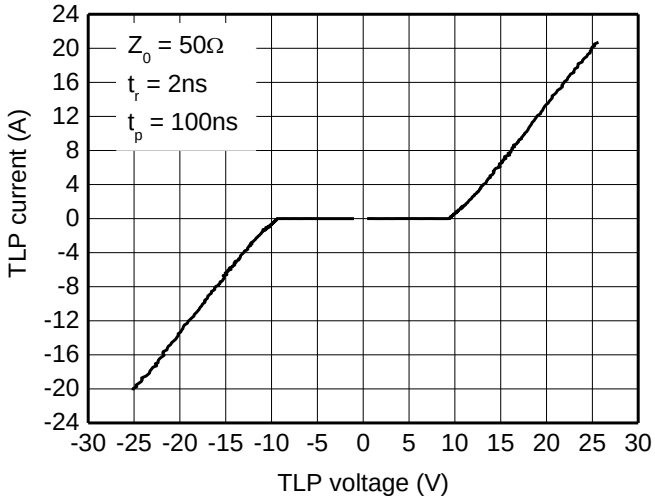
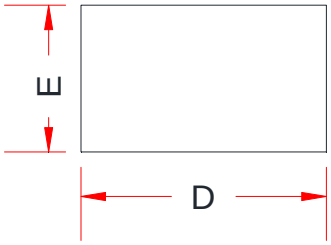


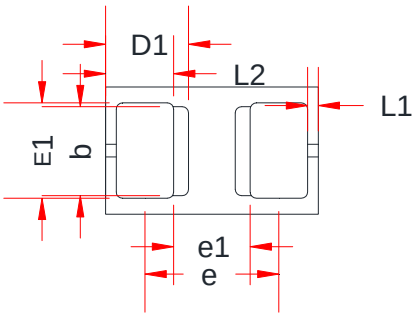
TLP Measurement

PACKAGE OUTLINE DIMENSIONS

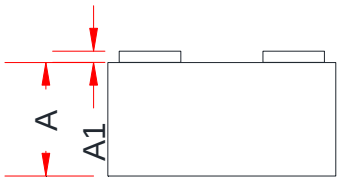
WBFBP-02C-C



TOP VIEW



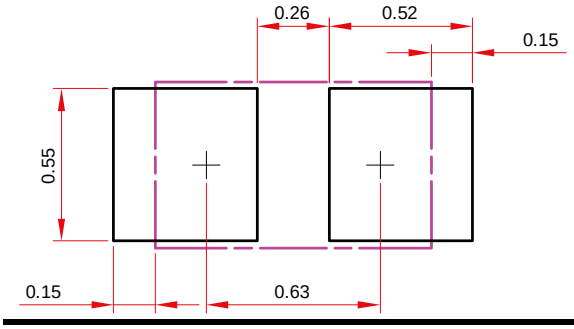
BOTTOM VIEW



SIDE VIEW

Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	0.45	0.50	0.55
A1	0.01	0.05	0.09
D	0.95	1.00	1.05
E	0.55	0.60	0.65
D1		0.39Ref	
E1	0.40	0.45	0.50
b		0.42Ref	
e	0.58	0.63	0.68
e1		0.36Ref	
L1		0.05Ref	
L2	0.27	0.32	0.37

Recommended land pattern (Unit: mm)

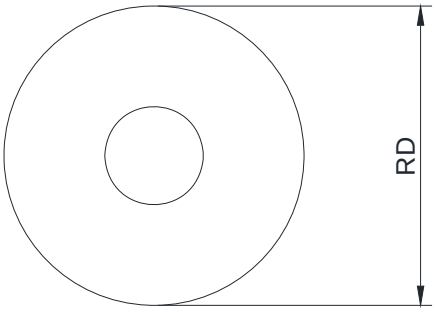


Notes:

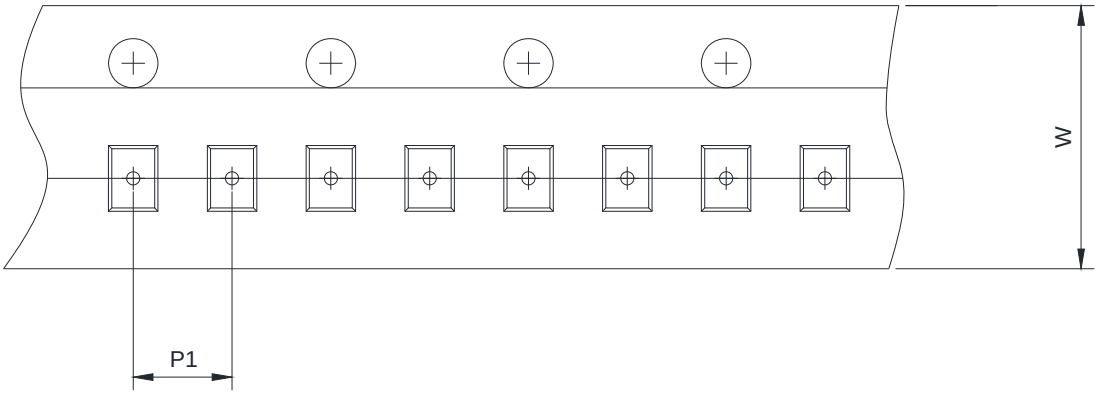
This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met.

TAPE AND REEL INFORMATION

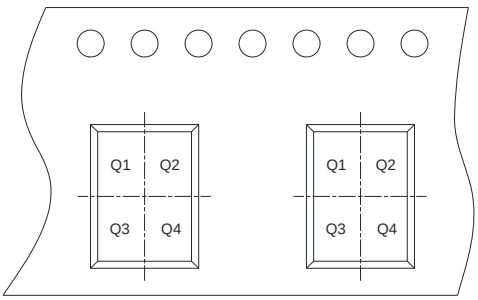
Reel Dimensions



Tape Dimensions



Quadrant Assignments For PIN1 Orientation In Tape



User Direction of Feed

RD	Reel Dimension	☑ 7inch	☐ 13inch		
W	Overall width of the carrier tape	☑ 8mm	☐ 12mm	☐ 16mm	
P1	Pitch between successive cavity centers	☑ 2mm	☐ 4mm	☐ 8mm	
Pin1	Pin1 Quadrant	☑ Q1	☑ Q2	☐ Q3	☐ Q4